



Sony Mobile Communications, Inc.

4-12-3 Higashi-shinagawa, Shinagawa-ku, Tokyo, 140-0002, Japan

Remarks

This document is managed in Infodoc.

Date: January 16, 2018

Internal Photos

FCC: PY7-77587P

1. Remove Pad Front cover





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2. Remove the Cabinet





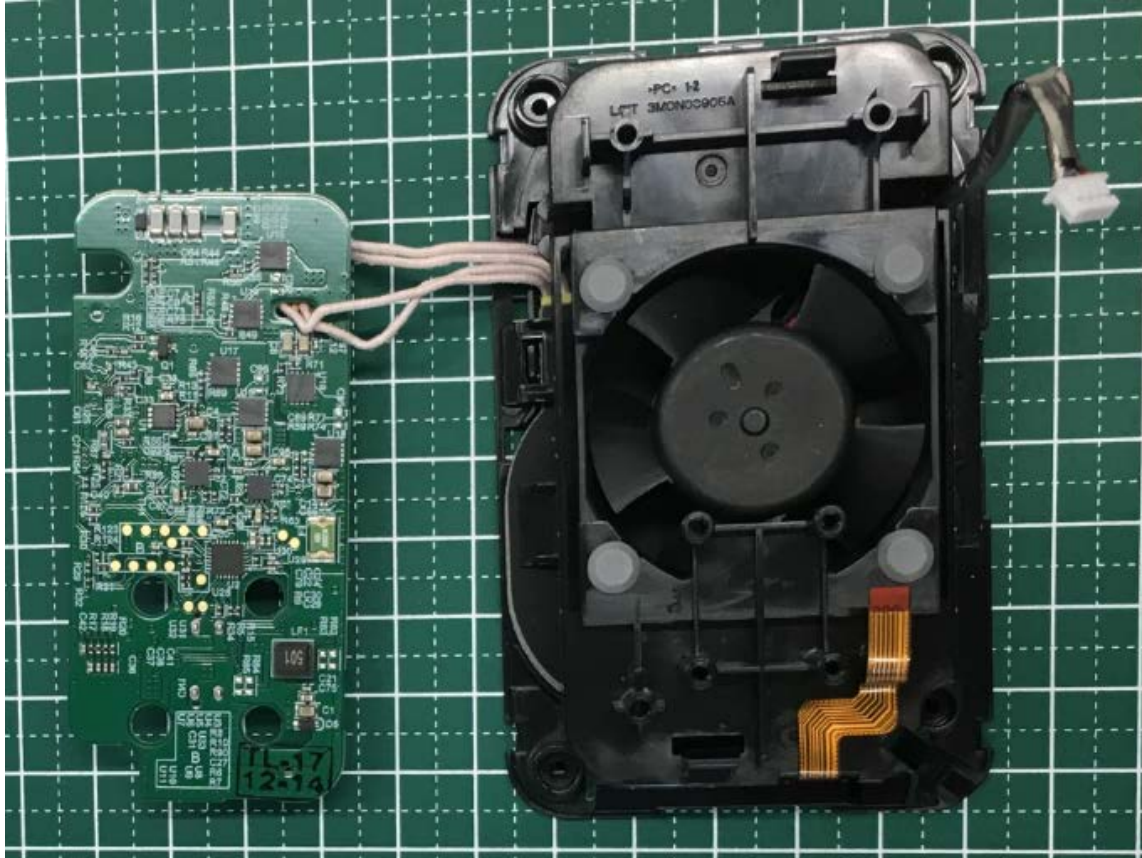
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3. PCB and Chassis with Fan



4. PCB, Coil, and Cover Front



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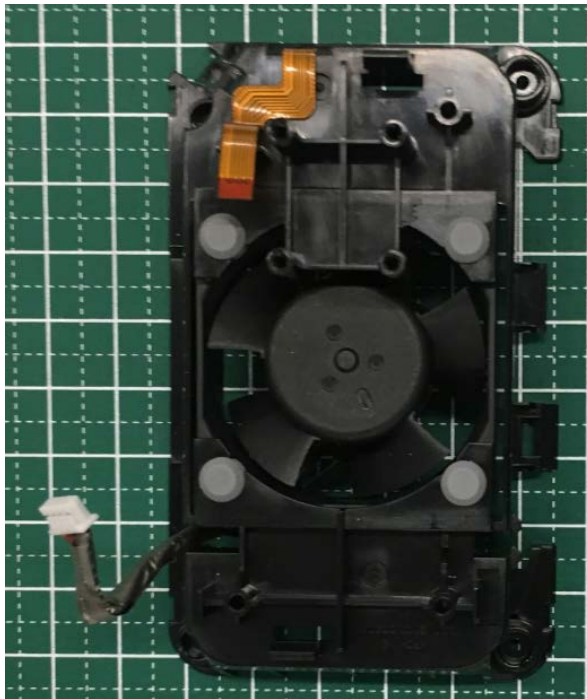
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5. Fan with Chassis



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